Tool ID: 1607 Tool Location: 220

## **Equipment Information Sheet**

# Hitachi TM3000 SEM

Manager: Xinwei Wu 607-254-4934 Backup: Alan R. Bleier 607-254-4931 their cell phones during accessible hours. At other times leave a message or send them an email.

Calls to staff phones will be automatically forwarded to

## **SAFETY**

No unusual hazards during operation.

## **USAGE RESTRICTIONS**

No buddy system restrictions imposed on normal operation.

#### SCHEDULING/SIGN-UP RESTRICTIONS

Minimum Tool Time: 0 minutes

None

## MATERIALS COMPATIBILITY CATEGORY

| Tool Category 5: Class A and B Metals and Compounds   |   |
|---|---|
| Allowed   | Not Allowed   |
| Tool category 1/1E, 2, 3, and 4 materials             |   |
| Silicon Based Substrates and Films                    |   |
| III/V compound Semiconductors                         |   |
| Glass Substrates                                      |   |
| PECVD and ALD Films                                   |   |
| Cured organics and baked Photoresist                  |   |
| CNF Class A, B, and Refractory metals                 |   |
| Exposed Gold, Silver, Copper                          |   |
| Alkali and Alkaline Compounds                         |   |
| Organic/Biology Molecules prepared-<br>w/salt buffers |   |
| High Vapor Pressure Materials (Mg, Ca, Zn)*           | * Some tool restrictions on high vapor pressure materials may apply |
| Soft organic materials                                |   |

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

## **Additional Material Restrictions and Exceptions**

None

Last Updated: 01/13/2022